

FIG. 1

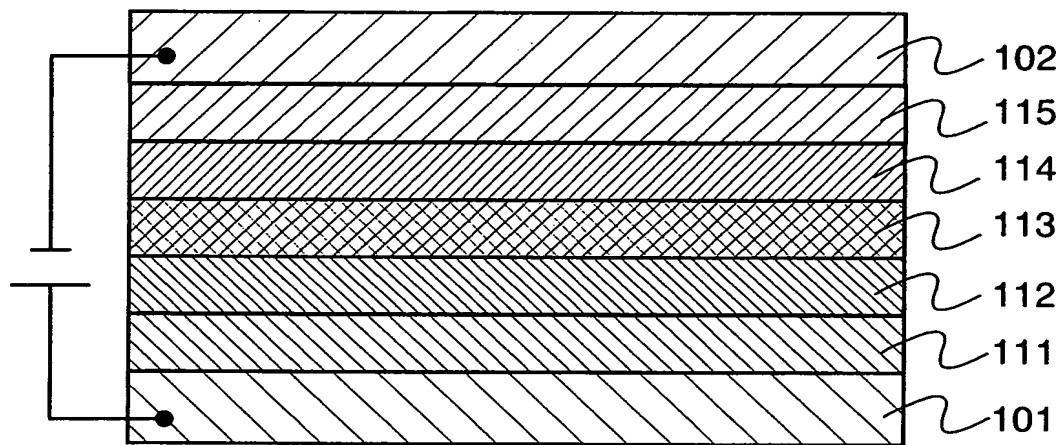


FIG. 2

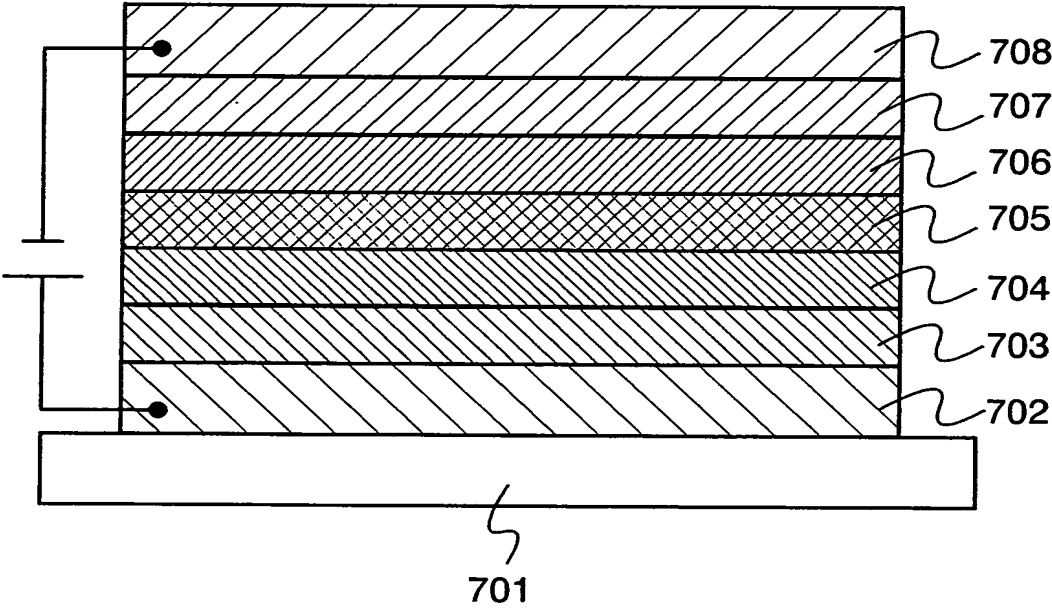


FIG. 3

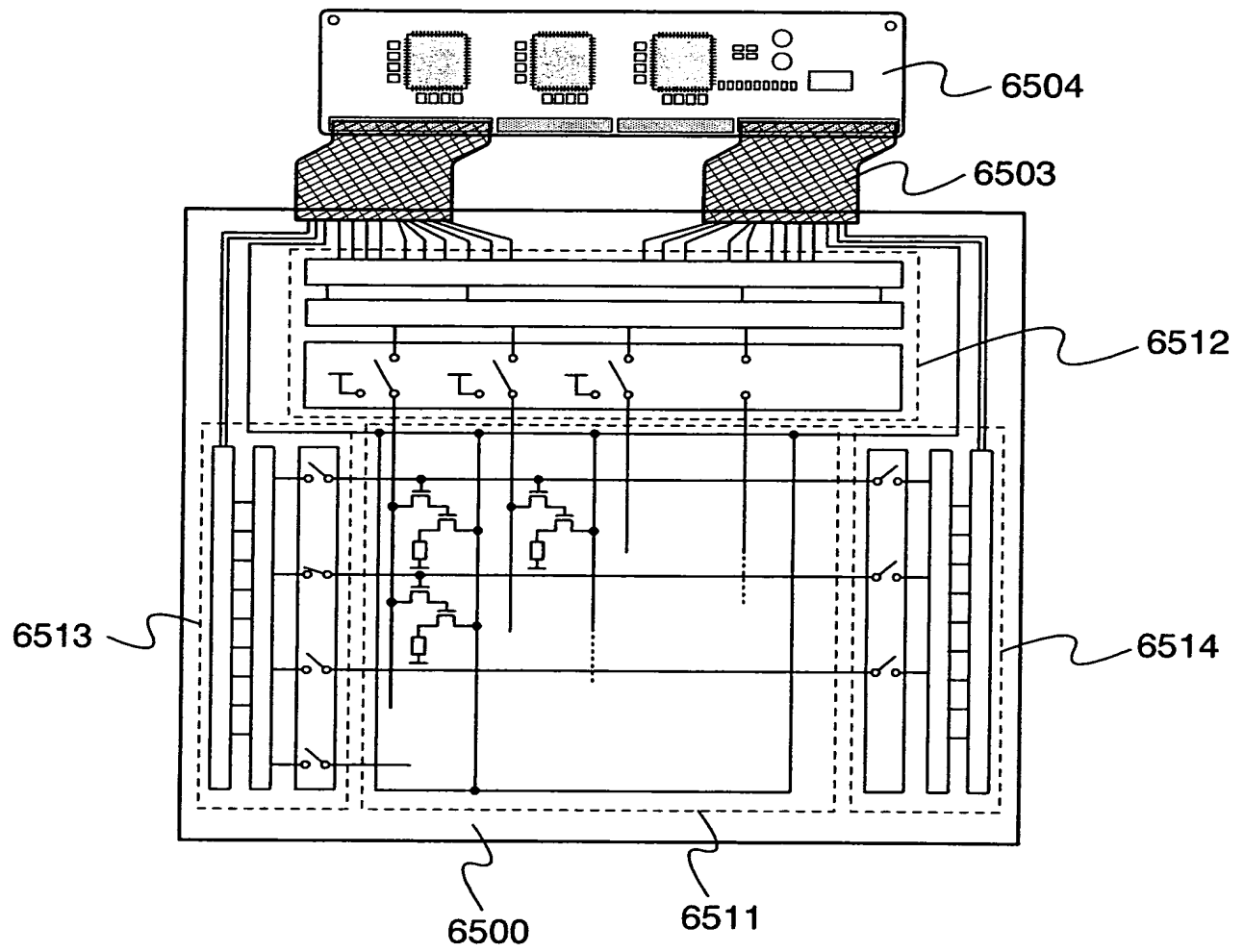


FIG. 4

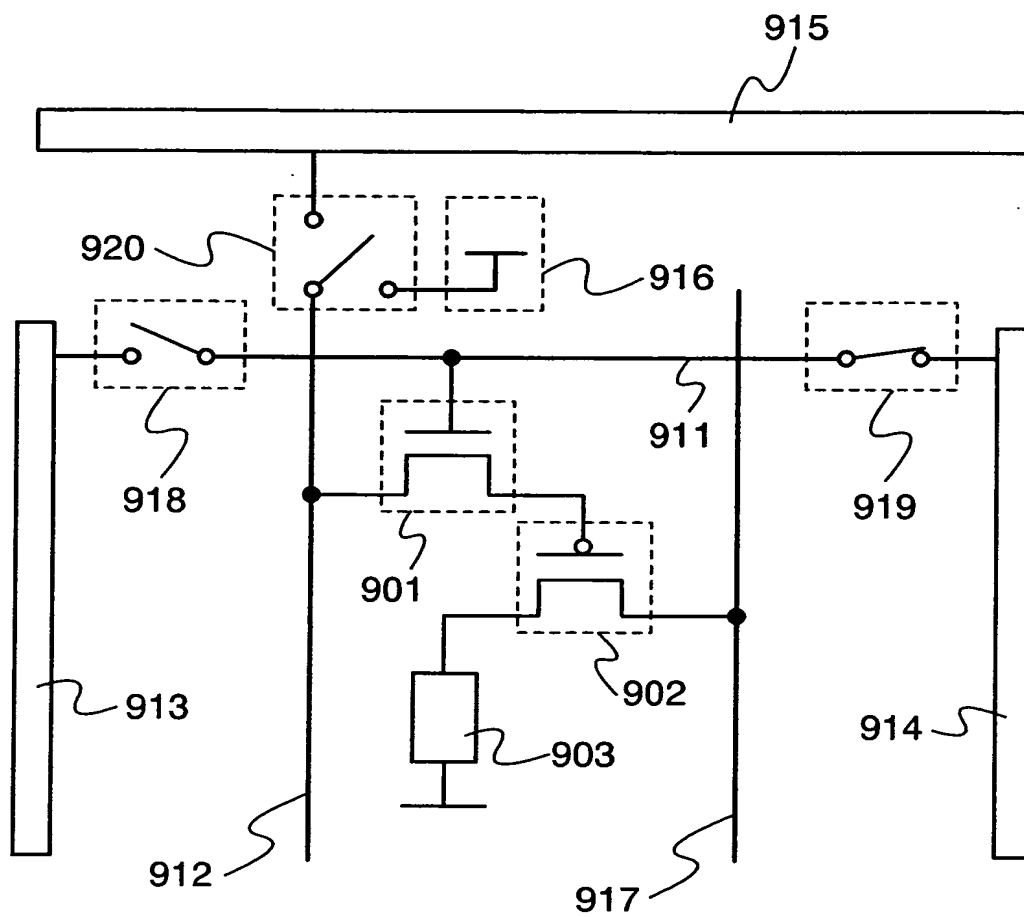


FIG. 5

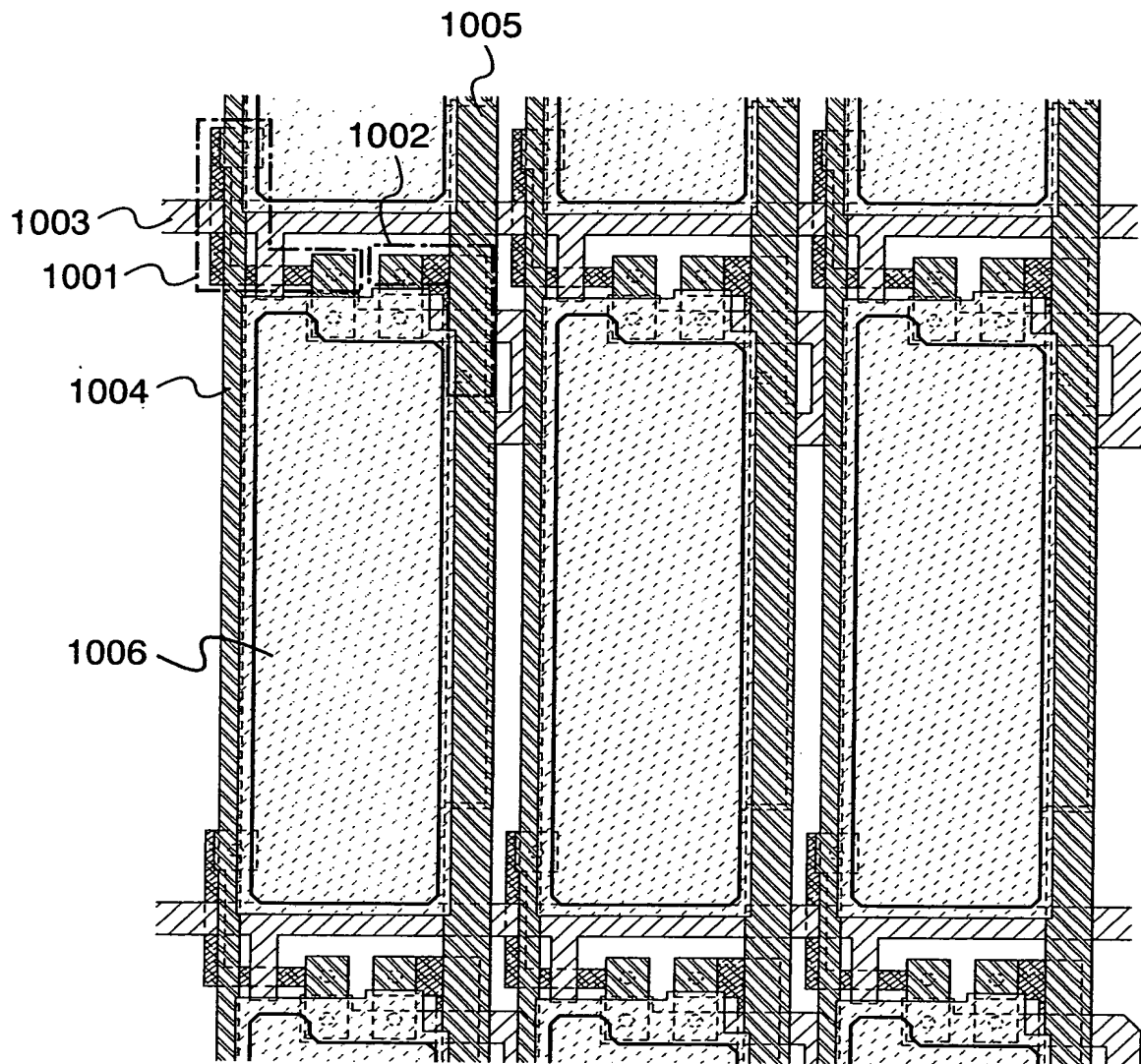


FIG. 6

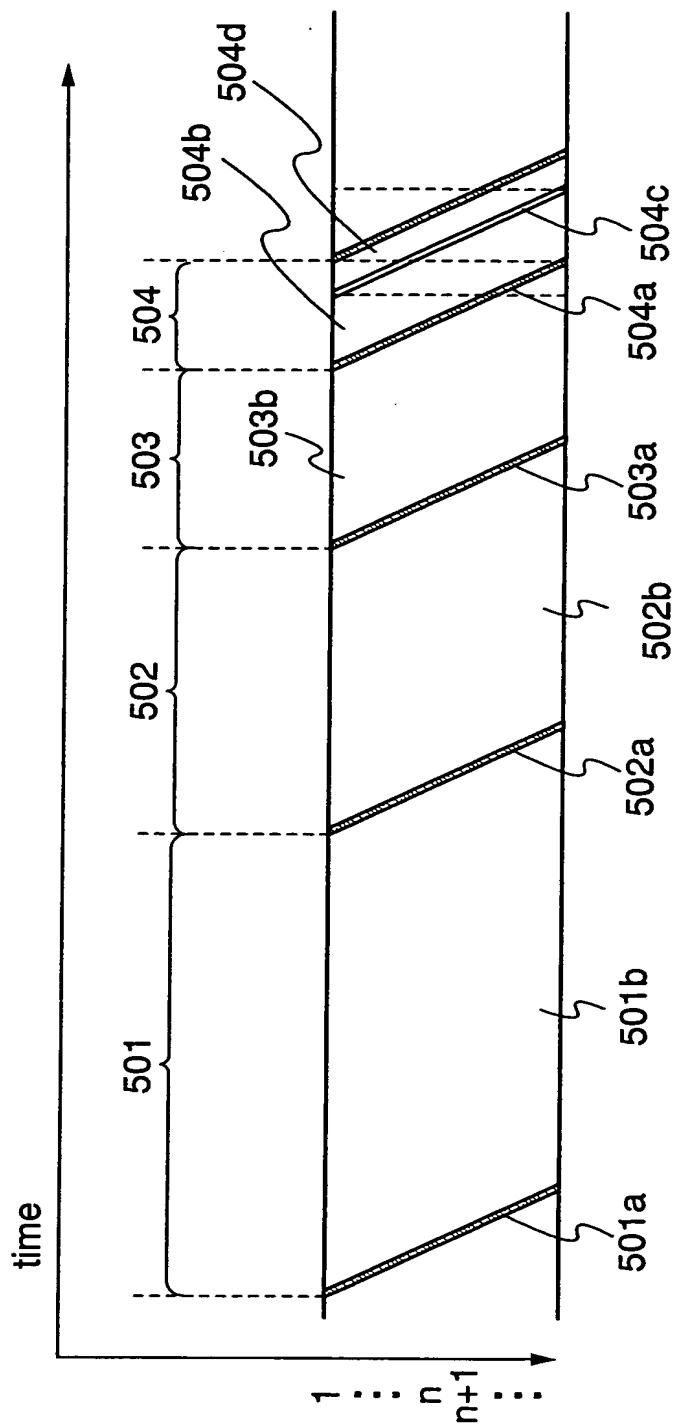


FIG. 7A

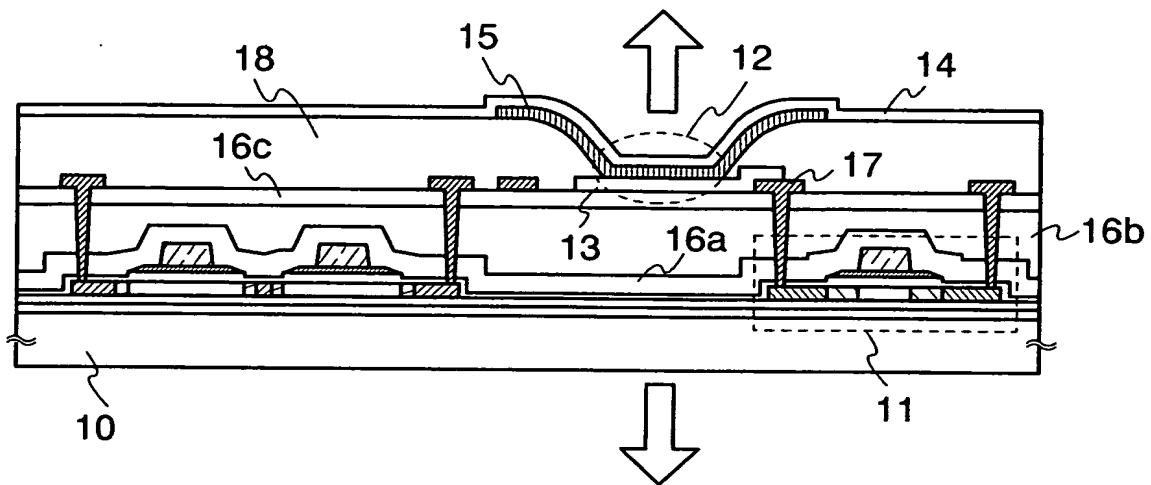


FIG. 7B

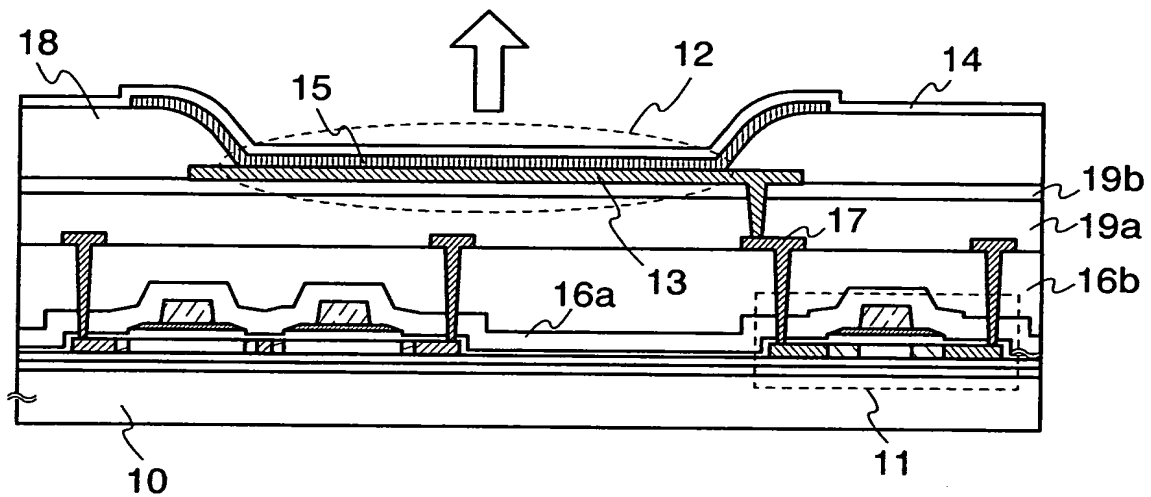


FIG. 7C

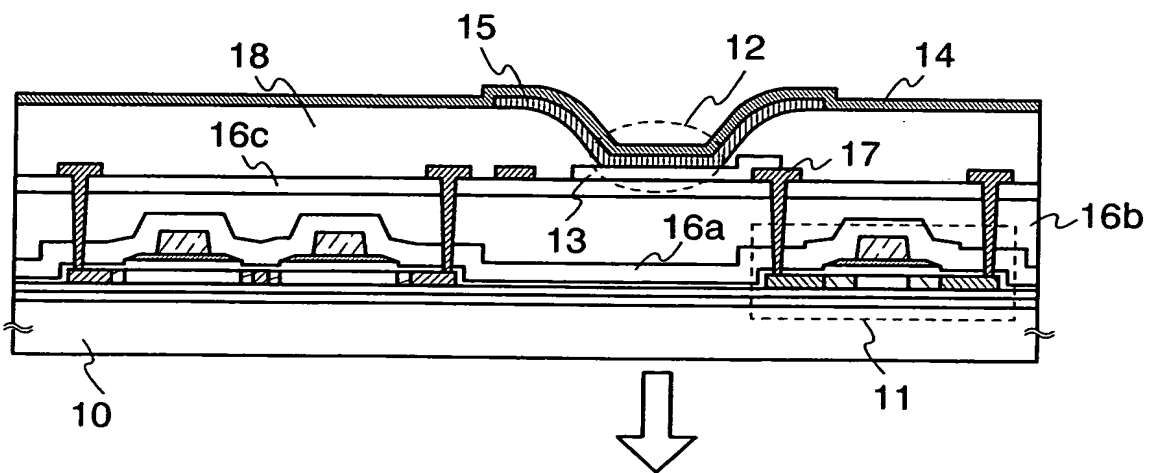


FIG. 8A

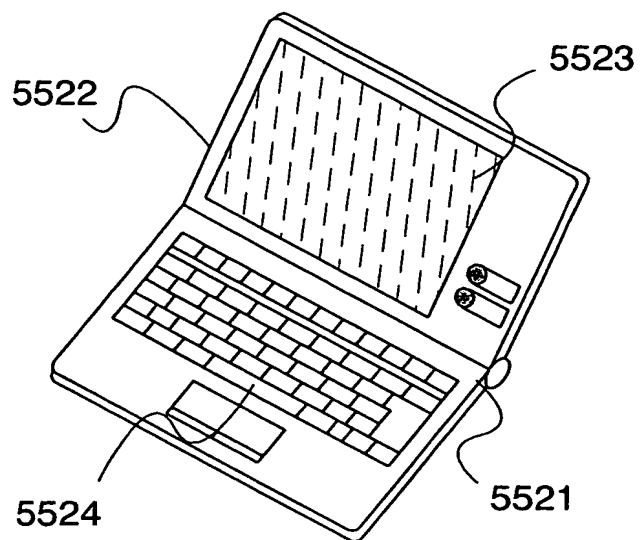


FIG. 8B

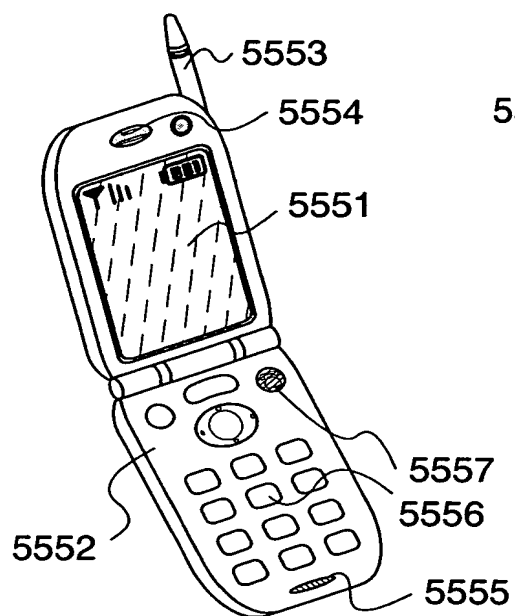


FIG. 8C

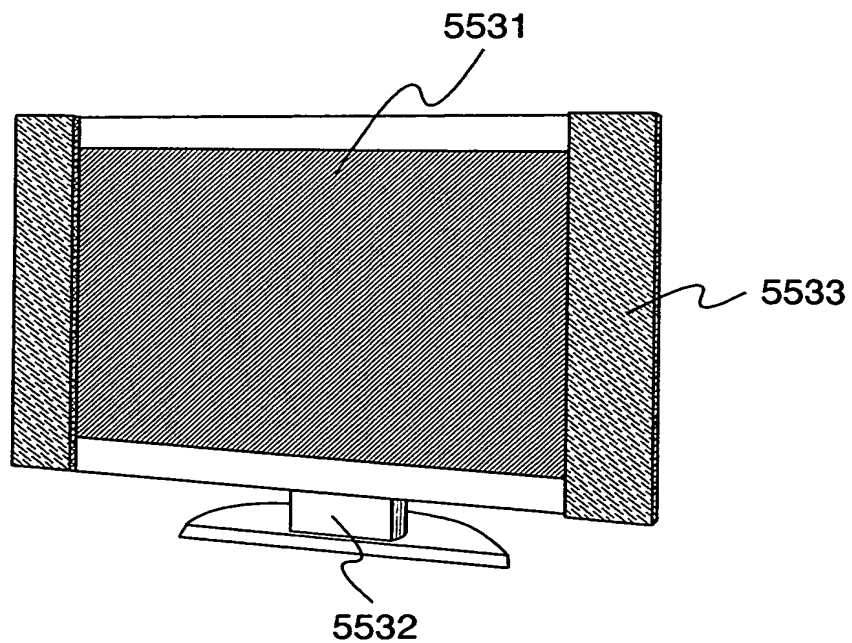


FIG. 9

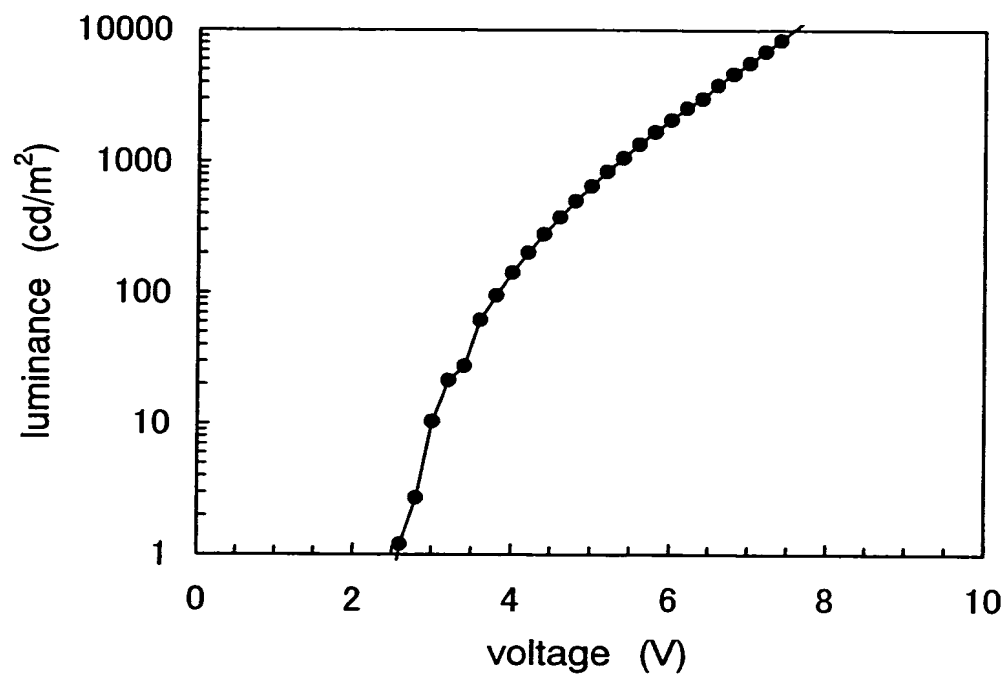


FIG. 10

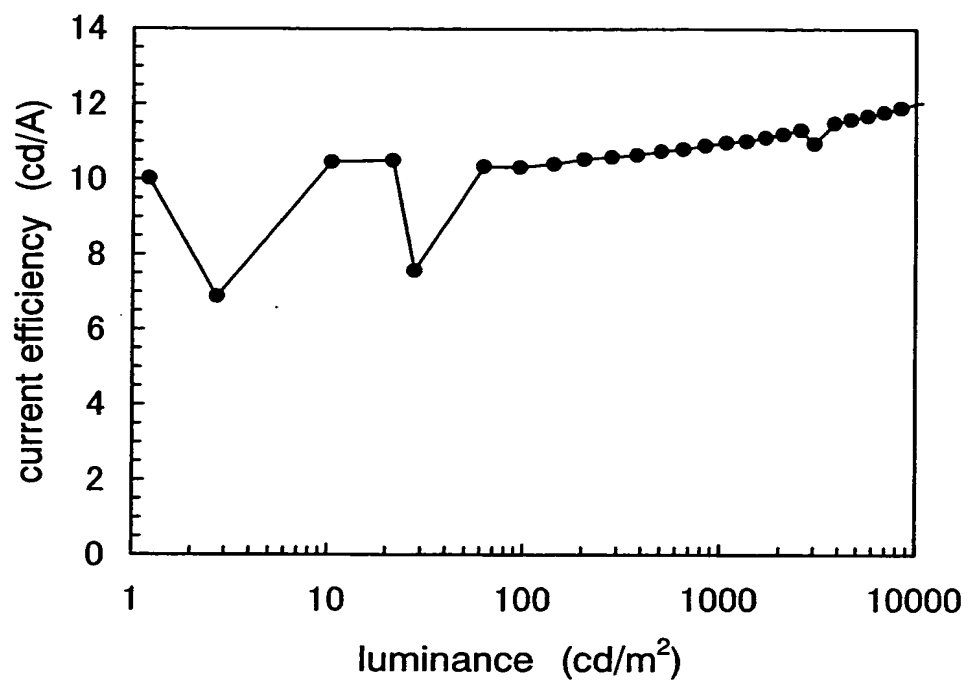


FIG. 11

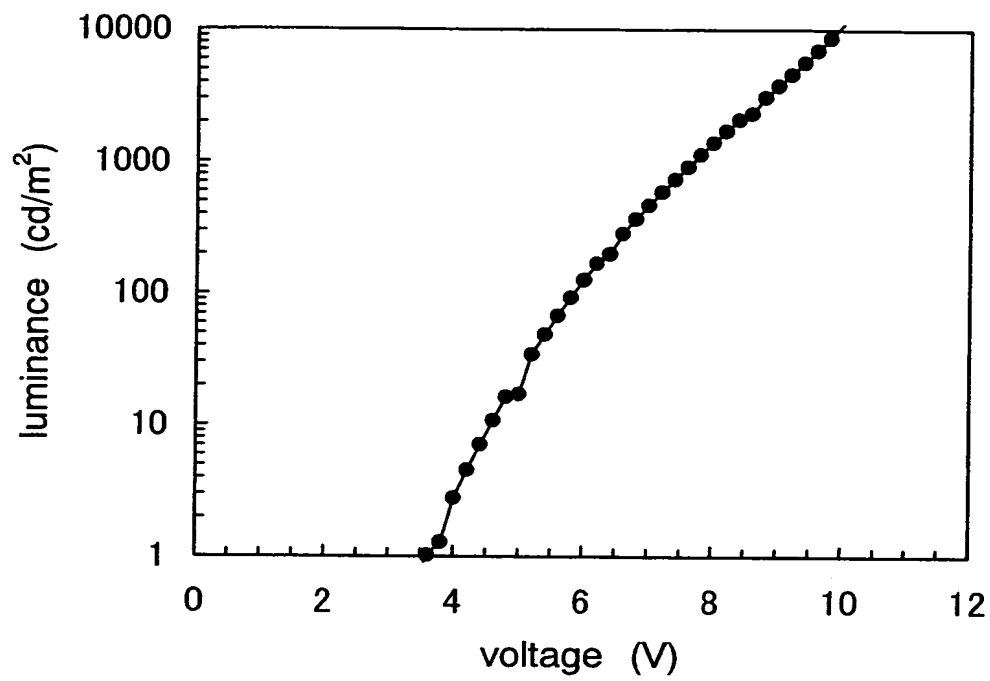
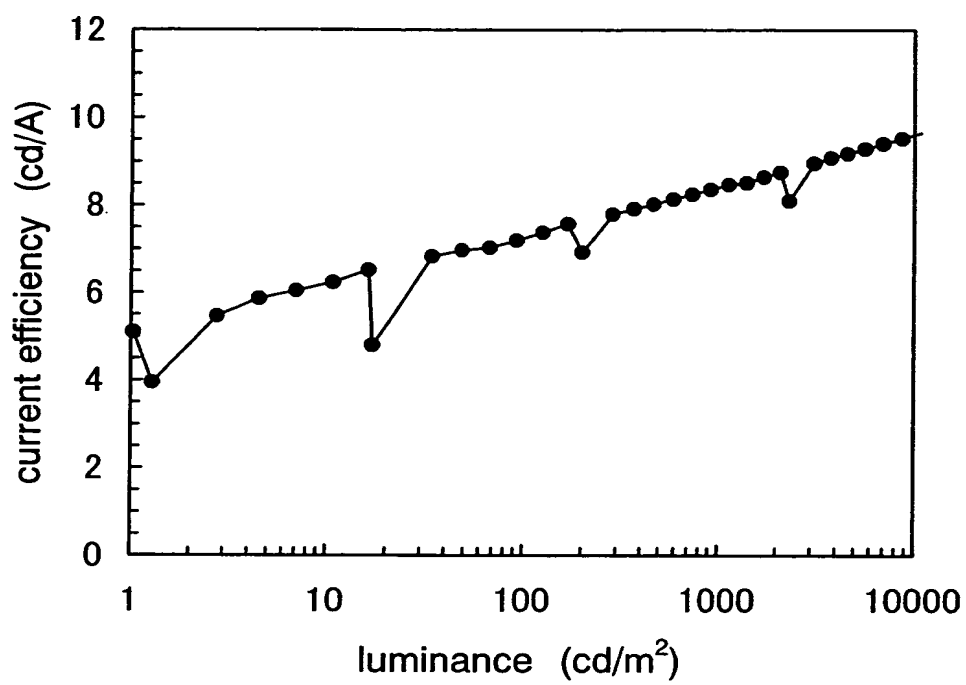


FIG. 12



EXPLANATION OF REFERENCE

101: first electrode, 102: second electrode, 111: hole injecting layer, 112: hole transporting layer, 113: light-emitting layer, 114: electron transporting layer, 115: electron injecting layer, 6500: substrate, 6511: pixel portion, 6512: source signal line driver circuit, 6513: writing gate signal line driver circuit, 6514: erasing gate signal line driver circuit, 6503: FPC (flexible printed circuit), 6504: printed wiring board (PWB), 901: first transistor, 902: second transistor, 903: light-emitting element, 911: gate signal line, 912: source signal line, 913: writing gate signal line driver circuit, 914: erasing gate signal line driver circuit, 915: source signal line driver circuit, 916: power source, 917: current supply line, 918: switch, 919: switch, 920: switch, 1001: first transistor, 1002: second transistor, 1003: gate signal line, 1004: source signal line, 1005: current supply line, 1006: power source, 501a: writing period, 501b: retention period, 501: first sub-frame, 502: second sub-frame, 503: third sub-frame, 504: fourth sub-frame, 504a: writing period, 504b: retention period, 504c: erasing period, 504d: non-emission period, 10: substrate, 11: transistor, 12: light-emitting element, 13: first electrode, 14: second electrode, 15: light-emitting layer, 16: first interlayer insulating film, 17: wiring, 18: partition layer, 19: second interlayer insulating film, 5521: main body, 5522: frame body, 5523: display portion, 5524: keyboard, 5551: display portion, 5552: main body, 5553: antenna, 5554: sound output portion, 5555: sound input portion, 5556: operation key, 5557: operation key, 5531: main body, 5532: frame body, 5533: speaker, 701: substrate, 702: first electrode, 703: first layer, 704: second layer, 705: third layer, 706: fourth layer, 707: fifth layer, 708: second electrode